# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# MBD101G, MMBD101LT1G

## **Schottky Barrier Diodes**

Designed primarily for UHF mixer applications but suitable also for use in detector and ultra-fast switching circuits. Supplied in an inexpensive plastic package for low-cost, high-volume consumer requirements. Also available in Surface Mount package.

#### Features

- Low Noise Figure 6.0 dB Typ @ 1.0 GHz
- Very Low Capacitance Less Than 1.0 pF
- High Forward Conductance 0.5 V (Typ) @  $I_F = 10 \text{ mA}$
- These Devices are Pb-Free and are RoHS Compliant

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Reverse Voltage	V <sub>R</sub>	7.0	V
$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	P <sub>F</sub>	280 225 2.2 1.8	mW mW/°C
Junction Temperature	TJ	+150	°C
Storage Temperature Range	T <sub>stg</sub>	–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25	5°C unless otherwise noted)
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		-			
Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage (I <sub>R</sub> = 10 μA)	V <sub>(BR)R</sub>	7.0	10	-	V
Diode Capacitance (V <sub>R</sub> = 0, f = 1.0 MHz, Note 1, page 2)	CD	-	0.88	1.0	pF
Forward Voltage (I <sub>F</sub> = 10 mA)	V <sub>F</sub>	-	0.5	0.6	V
Reverse Leakage (V <sub>R</sub> = 3.0 V)	Ι <sub>R</sub>	-	0.02	0.25	μΑ

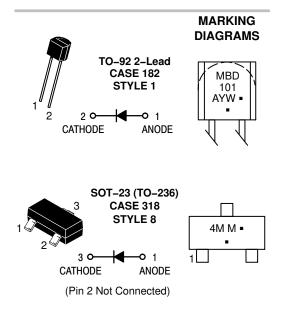
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



### **ON Semiconductor®**

#### www.onsemi.com

### SILICON SCHOTTKY BARRIER DIODES



- Y = Year
- W = Work Week
- 4M = Device Code (SOT-23)
- M = Date Code\*
- = Pb–Free Package

(Note: Microdot may be in either location) \*Date Code orientation and/or overbar may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

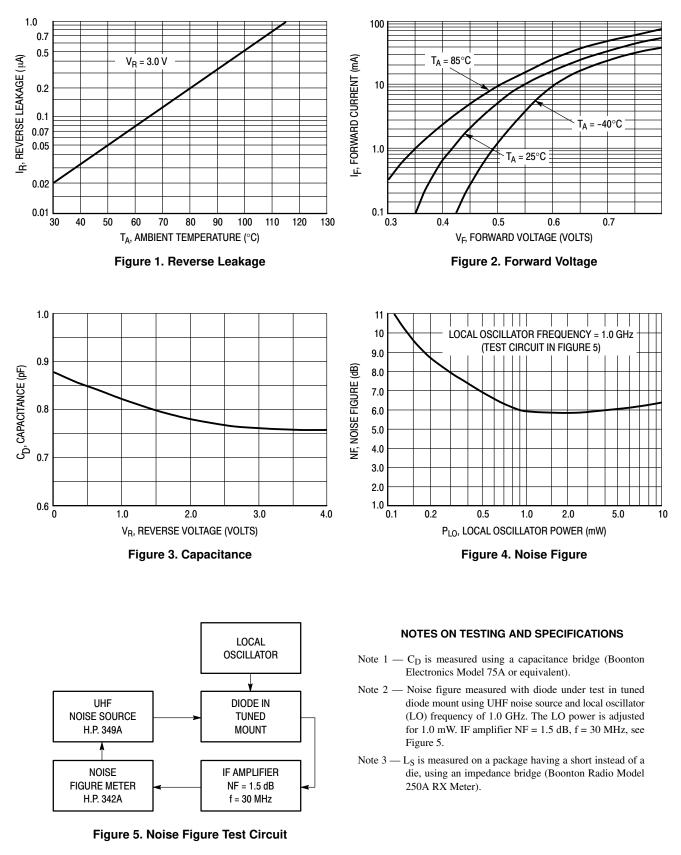
Device	Package	Shipping <sup>†</sup>
MBD101G	TO-92 (Pb-Free)	5000 Units / Box
MMBD101LT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel

<sup>+</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### MBD101G, MMBD101LT1G

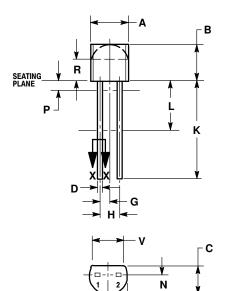
#### **TYPICAL CHARACTERISTICS**

 $(T_A = 25^{\circ}C \text{ unless noted})$ 



#### PACKAGE DIMENSIONS

TO-92 TWO LEAD TO-226AC CASE 182-06 **ISSUE L** 



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NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. CONTOUR OF PACKAGE BEYOND ZONE R IS UNCONTROLLED.
4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

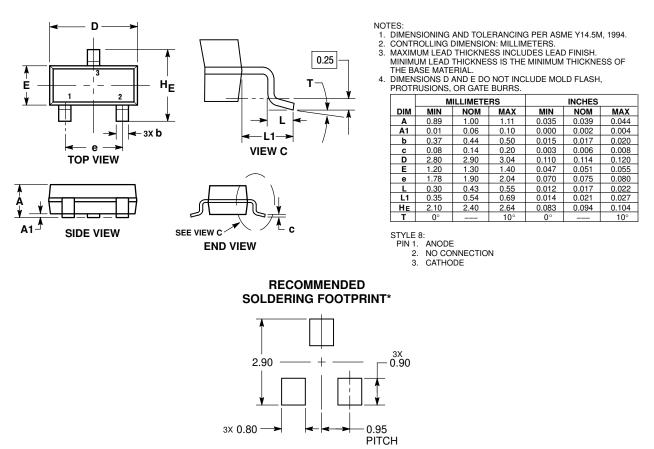
	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.21	
В	0.170	0.210	4.32	5.33	
С	0.125	0.165	3.18	4.19	
D	0.016	0.021	0.407	0.533	
G	0.050 BSC		1.27 BSC		
Н	0.100 BSC		2.54 BSC		
J	0.014	0.016	0.36	0.41	
K	0.500		12.70		
L	0.250		6.35		
Ν	0.080	0.105	2.03	2.66	
Ρ		0.050		1.27	
R	0.115		2.93		
٧	0.135		3.43		

STYLE 1: PIN 1. ANODE 2. CATHODE

#### MBD101G, MMBD101LT1G

#### PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 ISSUE AR



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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